

UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/608,605	06/27/2003	Kong Weng Lee	70030259-1	2253	
7590 09/27/2005			EXAMINER		
AGILENT TECHNOLOGIES, INC.			OWENS, DOUGLAS W		
Legal Department, DL429 Intellectual Property Administration			ART UNIT	PAPER NUMBER	
P.O. Box 7599			2811		
Loveland, CO	80537-0599		DATE MAILED: 00/27/200	DATE MAILED: 00/27/2005	

Please find below and/or attached an Office communication concerning this application or proceeding.

			N				
		Application No.	Applicant(s)				
		10/608,605	LEE ET AL.				
O	ffice Action Summary	Examiner	Art Unit				
		Douglas W. Owens	2811				
The Period for Rep	MAILING DATE of this communication appoly	ears on the cover sheet with the c	correspondence address				
WHICHEVI - Extensions of after SIX (6) - If NO period - Failure to repair Any reply rec	ENED STATUTORY PERIOD FOR REPLY ER IS LONGER, FROM THE MAILING DA of time may be available under the provisions of 37 CFR 1.13 MONTHS from the mailing date of this communication. For reply is specified above, the maximum statutory period we only within the set or extended period for reply will, by statute, believed by the Office later than three months after the mailing at term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be ting vill apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).				
Status							
1)⊠ Resp	oonsive to communication(s) filed on 6/21/	<u>′05</u> .					
2a) This	This action is FINAL . 2b)⊠ This action is non-final.						
•							
close	ed in accordance with the practice under E	Ex parte Quayle, 1935 C.D. 11, 45	53 O.G. 213.				
Disposition of	Claims	•					
4)⊠ Clain	n(s) <u>1-20</u> is/are pending in the application.						
	4a) Of the above claim(s) is/are withdrawn from consideration.						
· <u> </u>	n(s) is/are allowed.						
·	Claim(s) <u>1-20</u> is/are rejected.						
	n(s) is/are objected to. n(s) are subject to restriction and/o	r election requirement					
O/L. Olali	are subject to restriction and of						
Application Pa	apers						
• ——	specification is objected to by the Examine		_				
•	drawing(s) filed on is/are: a) ☐ acce						
	cant may not request that any objection to the acement drawing sheet(s) including the correct	=					
	oath or declaration is objected to by the Ex						
Priority under	35 U.S.C. § 119						
12)∐ Ackno	owledgment is made of a claim for foreign b) ☐ Some * c) ☐ None of:	priority under 35 U.S.C. § 119(a))-(d) or (f).				
1.	Certified copies of the priority documents	s have been received.					
2.		•					
3.	Copies of the certified copies of the prior		ed in this National Stage				
* 0 46	application from the International Bureau		- al				
See in	e attached detailed Office action for a list	or the certified copies not receive	eu.				
Attachment(s)							
	eferences Cited (PTO-892)	4) Interview Summary					
2) Notice of Dr	raftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail D					
	Disclosure Statement(s) (PTO-1449 or PTO/SB/08) //Mail Date	6) Other:	and the state of t				

DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on June 21, 2005 has been entered.

Claim Objections

2. Claims 1 – 10 are objected to because of the following informalities: in line 7 of claim 1, --of the substrate-- should be inserted after "surfaces", since a major surface of the die is also referenced in the claim. Appropriate correction is required.

Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. Claims 1, 2, 6, 7, 11, 12, 16 and 18 are rejected under 35 U.S.C. 102(b) as being anticipated by US Patent No. 6,268,654 to Glenn et al.

Regarding claims 1 and 11, Glenn et al. teach a packaging device for a semiconductor die, (Fig. 5) comprising:

a substantially planar substrate (200) having opposed major surfaces;

a conductive die mounting pad (222) dimensioned to accommodate the die (100), the pad being located on one of the major surfaces, and in contact with a major surface of the die;

a conductive connecting pad (221) located on the other of the major surfaces of the substrate; and

a conductive interconnecting element (220) extending through the substrate and electrically interconnecting the mounting pad and the connecting pad.

Regarding claims 2, 7, 12 and 18, Glenn et al. teach a device, in which the substrate comprises ceramic (Col. 5, lines 19 - 27).

Regarding claims 6 and 16, Glenn et al. teach a device, further comprising:

a bonding pad (204) smaller in area than the die mounting pad, the bonding pad located on the one of the major surfaces;

an additional conductive connecting pad (209) located on the other of the major surfaces; and

an additional conductive interconnecting element (203) extending through the substrate and electrically interconnecting the bonding pad and the additional connecting pad.

Claim Rejections - 35 USC § 103

- 5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Application/Control Number: 10/608,605

Art Unit: 2811

6. Claims 4, 5, 9, 14, 15, 19 and 20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Glenn et al.

Regarding claims 4, 9, 14 and 19, Glenn et al. teach a device, wherein the mounting pad comprises one of copper and gold (Col. 12, lines 40 – 44). Glenn et al. do not teach forming the connecting pad and the bonding pad to comprise copper, silver, gold, nickel or tungsten. Copper, silver, gold, nickel and tungsten are well known materials that are well suited for the intended use. It would have been obvious to one of ordinary skill in the art to use the cited materials, since it is desirable to use materials that are known and suited for the intended use. The selection of a known material based on its suitability for its intended use supported a *prima facie* obviousness determination in *Sinclair & Carroll Co. v. Interchemical Corp.*, 325 U.S. 327, 65 USPQ 297 (1945).

Regarding claims 5, 10, 15 and 20, Glenn et al. do not teach that the conductive interconnecting element comprises tungsten. Tungsten is a known material that is well suited for use in an interconnecting element. It would have been obvious to one of ordinary skill in the art to use tungsten for the interconnect since it is a known material that is well suited for the intended use.

7. Claims 3, 8 and 13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Glenn et al. as applied to claims 1, 6 and 11 above, and further in view of US Patent No. 6,191,477 to Hashemi.

Glenn et al. do not teach a device, wherein the substrate is an epoxy laminate or silicon. Hashemi teaches a device, wherein the substrate is an epoxy laminate (Col. 3,

Application/Control Number: 10/608,605

Art Unit: 2811

lines 1-7). It would have been obvious to one of ordinary skill in the art at the time the invention was made, to incorporate the teaching of Hashemi into the device taught by Glenn et al., since it is desirable to use materials that known and well suited for the intended use.

8. Claim 17 is rejected under 35 U.S.C. 103(a) as being unpatentable over Glenn et al. as applied to claim 16 above, and further in view of US Patent No. 6,084,295 to Horiuchi et al.

Glenn et al. do not teach a device further comprising an encapsulant encapsulating the semiconductor die and at least a portion of the major surface of the substrate on which the mounting pad is located. Horiuchi et al. teach an encapsulant encapsulating the semiconductor die and at least a portion of the major surface of the substrate on which the mounting pad is located. It would have been obvious to one of ordinary skill in the art to incorporate the teaching of Horiuchi et al. into the device taught by Glenn et al. since it desirable to protect the device from the elements.

Response to Arguments

9. Applicant's arguments with respect to claims 1 – 20 have been considered but are most in view of the new ground(s) of rejection.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Douglas W. Owens whose telephone number is 571-272-1662. The examiner can normally be reached on Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Steven H. Loke can be reached on 571-272-1657. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Douglas W Owens Examiner

Art Unit 2811

DWO